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7-31-02  
JA

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Ronald Redline, et al.

Serial No.: 09/698,370

Filed: October 26, 2000

Docket No.: 2156-056A

Title: Method For Enhancing the Solderability Of A Surface



Group Art Unit: 1741

Batch No.

Date of Mailing of Notice of  
Allowance and Issue Fee:  
April 12, 2002

Examiner: W. Nicolas

Box Issue Fee  
Assistant Commissioner for Patents  
Washington, D.C. 20231

**AMENDMENT AFTER NOTICE OF ALLOWANCE UNDER 37 CFR 1.312**

Prior to payment of the issue fee, please amend the above-entitled application as follows:

**IN THE SPECIFICATION**

✓ Please delete the paragraphs on page 13, line 1 through page 15, line 5 and  
✓ replace them with the following:

**EXAMPLE I**

IPC-B-25 test circuit boards were processed with the following steps:

- B<sub>1</sub>
- a). Acid Cleaner, 5 minutes, 120°F
  - b). Water Rinse
  - c). Sodium persulfate/sulfuric acid microetch, 1 minute, 95°F
  - d). Water rinse